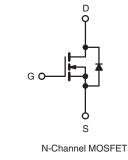


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Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	3.0			
Q _g (Max.) (nC)	17				
Q _{gs} (nC)	4.3				
Q _{gd} (nC)	8.5				
Configuration	Single				





FEATURES

• Low Gate Charge Q_q Results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS Ruggedness COMPLIANT
- Fully Characterized Capacitance and Avalanche Voltage and current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Two Transistor Forward
- Half bridge
- Full bridge

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF820APbF
	SiHF820A-E3
SnPb	IRF820A
	SiHF820A

ABSOLUTE MAXIMUM RATINGS ($T_c = 25$ °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	500	v			
Gate-Source Voltage			V _{GS}			± 30	
Continuous Drain Current	V_{GS} at 10 V $T_{C} = 25^{\circ}$ $T_{C} = 100^{\circ}$	T _C = 25 °C	L	2.5			
		T _C = 100 °C	I _D	1.6	A		
Pulsed Drain Current ^a			I _{DM}	10	1		
Linear Derating Factor			0.40	W/°C			
Single Pulse Avalanche Energy ^b		E _{AS}	140	mJ			
Repetitive Avalanche Current ^a			I _{AR}	2.5	A		
Repetitive Avalanche Energy ^a			E _{AR}	5.0	mJ		
Maximum Power Dissipation	T _C = 25 °C		P _D 50		W		
Peak Diode Recovery dV/dt ^c			dV/dt 3.4		V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C			
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d			
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in		
				1.1	N · m		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25$ °C, L = 45 mH, $R_g = 25 \Omega$, $I_{AS} = 2.5 A$ (see fig. 12). c. $I_{SD} \le 2.5 A$, dl/dt $\le 270 A/\mu s$, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-		62 - 2.5		°C/W		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50						
Maximum Junction-to-Case (Drain)	R _{thJC}	-						
	L							
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					-	-		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250 μA	500	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.60	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		2.0	-	4.5	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA	
Zero Gate Voltage Drain Current	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25				
	IDSS	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$	- O°	-	250	μA		
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 1.5 A ^b	-	-	3.0	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D = 1.5 A ^b	1.4	-	-	S	
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 $V_{GS} = 0 V; V_{DS} = 1.0 V, f = 1.0 MHz$ $V_{GS} = 0 V; V_{DS} = 400 V, f = 1.0 MHz$		-	340	-	pF	
Output Capacitance	C _{oss}			-	53	-		
Reverse Transfer Capacitance	C _{rss}			-	2.7	-		
Output Capacitance	C _{oss}			łz	490			
Output Capacitance	C _{oss}			Hz	15			
Effective Output Capacitance	C _{oss} eff.	V_{GS} = 0 V; V_{DS} = 0 V to 400 $V^{\rm c}$			28			
Total Gate Charge	Qg			-	-	17	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 2.5 \text{ A}, V_{DS} = 40$ see fig. 6 and 1		-	4.3		
Gate-Drain Charge	Q _{gd}			-	-	8.5		
Turn-On Delay Time	t _{d(on)}				8.1	-	- ns	
Rise Time	t _r	$V_{DD} = 250 \text{ V, } \text{I}_D = 2.5 \text{ A,}$ $\text{R}_\text{g} = 21 \ \Omega, \ \text{R}_\text{D} = 97 \ \Omega, \ \text{see fig. } 10^\text{b}$		-	12	-		
Turn-Off Delay Time	t _{d(off)}			jb _	16	-		
Fall Time	t _f			-	13	-		
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.5	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	10		
Body Diode Voltage	V_{SD}	$T_J=25~^\circ\text{C},~I_S=2.5~\text{A},~V_{GS}=0~\text{V}^b$		b _	-	1.6	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_{\rm J} = 25 \ ^{\circ}\text{C}, I_{\rm F} = 2.5 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{\rm b}$		- /us ^b	330	500	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			- μο	760	1140	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn	minated b	by L _S and	L _D)			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %. c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

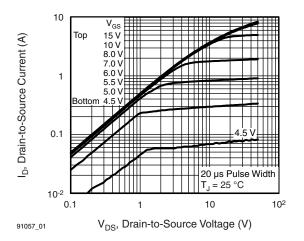
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



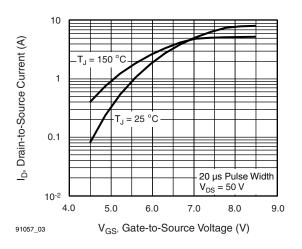


Fig. 3 - Typical Transfer Characteristics

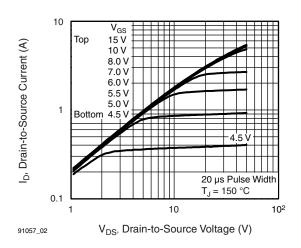


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

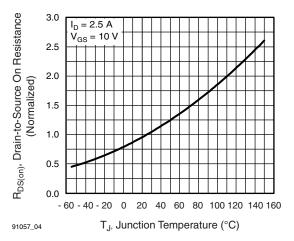


Fig. 4 - Normalized On-Resistance vs. Temperature

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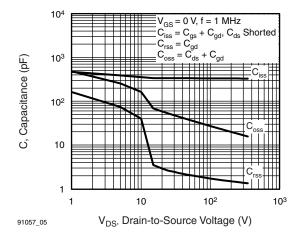


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

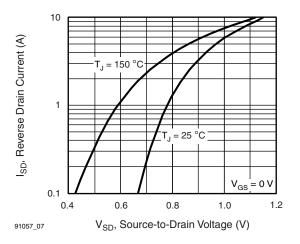


Fig. 7 - Typical Source-Drain Diode Forward Voltage

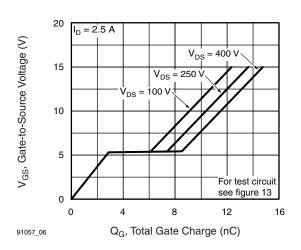


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

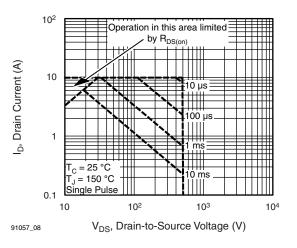


Fig. 8 - Maximum Safe Operating Area

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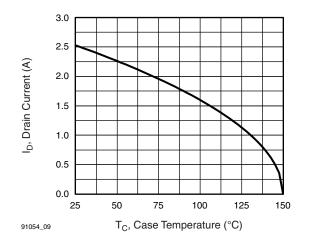


Fig. 9 - Maximum Drain Current vs. Case Temperature

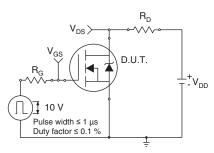


Fig. 10a - Switching Time Test Circuit

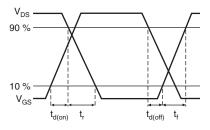


Fig. 10b - Switching Time Waveforms

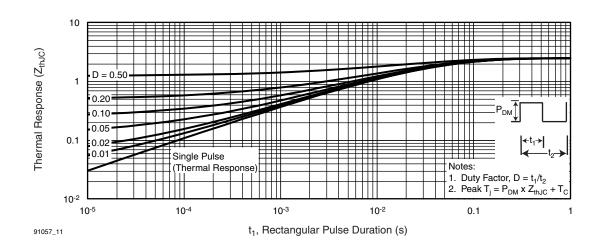


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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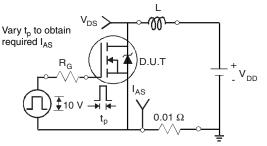


Fig. 12a - Unclamped Inductive Test Circuit

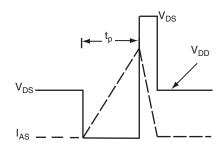


Fig. 12b - Unclamped Inductive Waveforms

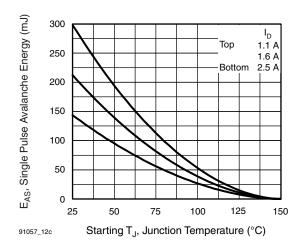


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

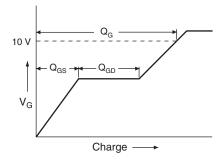


Fig. 12d - Basic Gate Charge Waveform

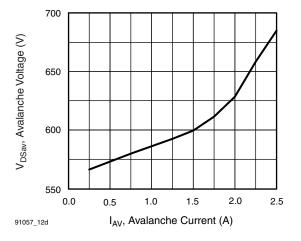


Fig. 13a - Typical Drain-to-Source Voltage vs. Avalanche Current

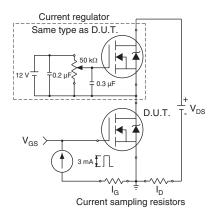


Fig. 13b - Gate Charge Test Circuit

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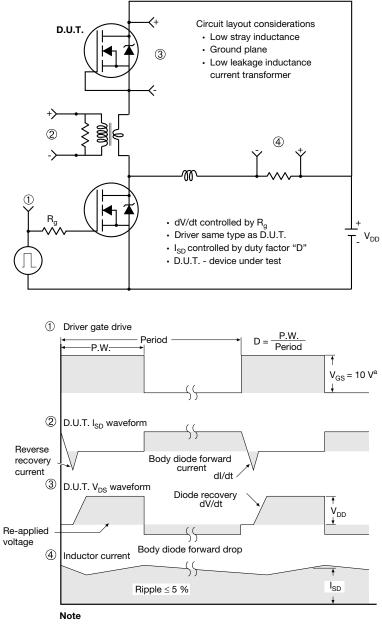
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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